

P H A S E C O N T R O L T H Y R I S T O R

T263-1250

<ul style="list-style-type: none"> ◆ $V_{DRM} = \underline{2800-3200 \text{ B}}$ ◆ $V_{RRM} = \underline{2800-3200 \text{ B}}$ ◆ $I_{T(AV)} = \underline{1550 \text{ A}}$ ($T_C = 70^\circ\text{C}$) ◆ $I_{T(AV)} = \underline{1257 \text{ A}}$ ($T_C = 85^\circ\text{C}$) ◆ $I_{TSM} = \underline{22.0 \text{ kA}}$ ($T_j = 125^\circ\text{C}$) 		
<ul style="list-style-type: none"> ◆ Amplifying gate ◆ Low on-state switching losses ◆ Acceptable for series and parallel connections ◆ Low dispersion Q_{rr}, V_{TM}, I_{DRM} 		

MAXIMUM RATED VALUES

Parameter and conditions	Symbol	Values	Units
Repetitive peak off-state voltage, $T_j = -60 \dots +125^\circ\text{C}$	V_{DRM}	2800-3200	V
Repetitive peak reverse voltage, $T_j = -60 \dots +125^\circ\text{C}$	V_{RRM}	2800-3200	
Non-repetitive peak off-state voltage, $T_j = -60 \dots +125^\circ\text{C}$	V_{DSM}	2900-3300	
Non-repetitive peak reverse voltage, $T_j = -60 \dots +125^\circ\text{C}$	V_{RSM}	2900-3300	
Repetitive peak off-state current/ Repetitive peak reverse current, $T_j = 125^\circ\text{C}$, $V_D / V_R = V_{DRM} / V_{RRM}$	I_{DRM} / I_{RRM}	100	mA
Average on-state current, $f = 50 \text{ Hz}$, double side cooling, $T_C = 85^\circ\text{C}$ $T_C = 70^\circ\text{C}$	$I_{T(AV)}$	1257 1550	A
RMS on-state current, $f = 50 \text{ Hz}$, $T_C = 70^\circ\text{C}$	I_{TRMS}	2520	A
Surge non-repetitive on-state current, $T_j = 125^\circ\text{C}$, $V_R = 0$, $t_p = 10 \text{ ms}$	I_{TSM}	22.0	kA
Safety factor	I^2t	$3.1 \cdot 10^6$	A^2s
Critical rate of rise of on-state current, $T_j = 125^\circ\text{C}$, $V_D = 0.67V_{DRM}$, $I_T = 2500 \text{ A}$, $I_{FG} = 2 \text{ A}$, $t_r = 1 \mu\text{s}$, $f = 50 \text{ Hz}$	$(di_T/dt)_{crit}$	200	$\text{A}/\mu\text{s}$
Critical rate of rise of off-state voltage, $T_j = 125^\circ\text{C}$, $V_D = 0.67V_{DRM}$	$(dv_D/dt)_{crit}$	1600	$\text{V}/\mu\text{s}$
Gate power loss, DC	P_{GM}	4	W
Operation junction temperature range	T_j	-60... +125	$^\circ\text{C}$
Storage temperature range	T_{stg}	-60... +50	

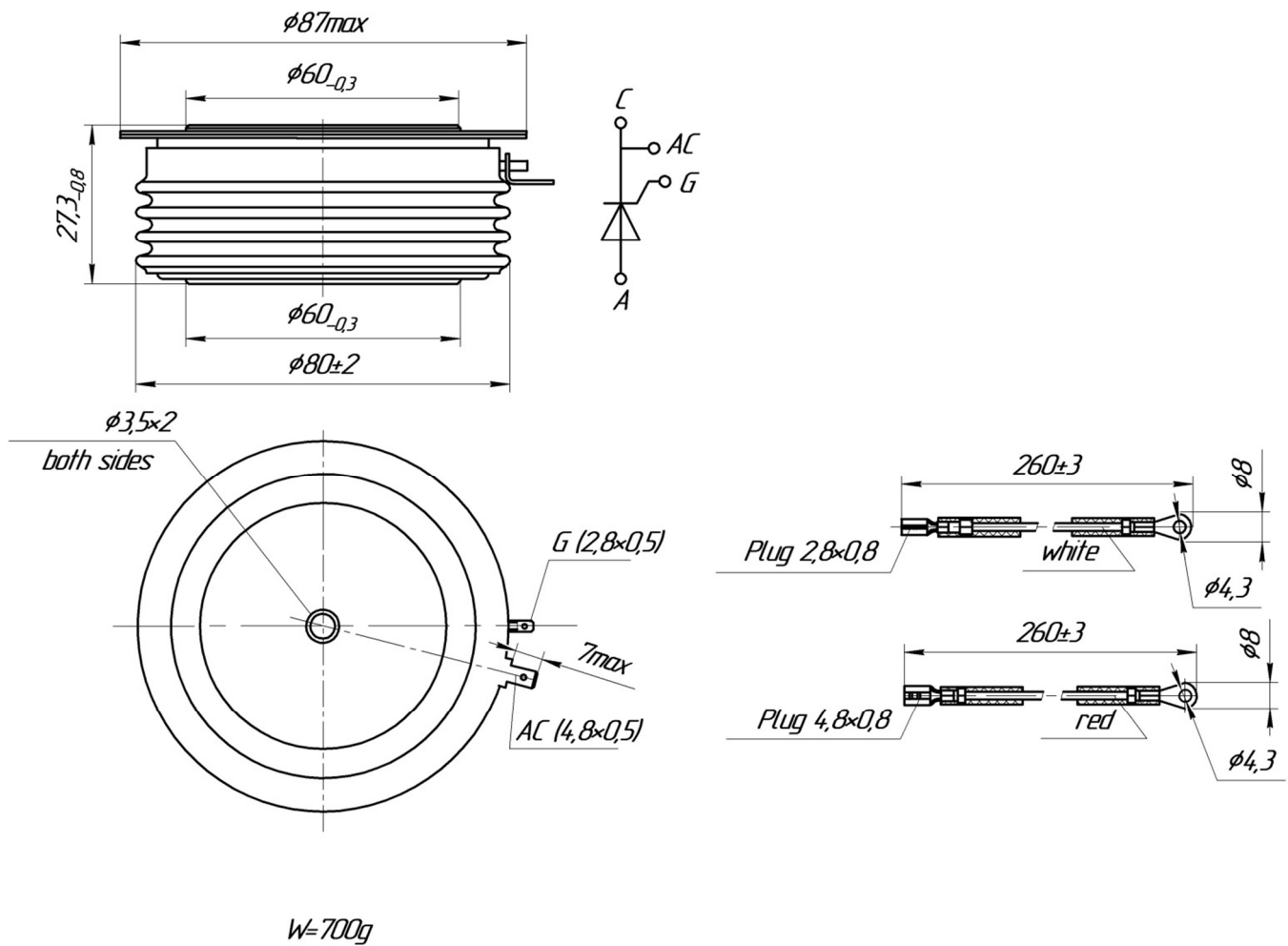


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ELECTRICAL CHARACTERISTICS					
Parameter and conditions	Symbol	Values			Units
		min	typ.	max	
Peak on-state voltage, $T_j = 25\text{ }^\circ\text{C}$, $I_T = 3927\text{ A}$	V_{TM}	-	-	2.0	V
On-state threshold voltage, $T_j = 125\text{ }^\circ\text{C}$, $I_T = 1963\text{-}5890\text{ A}$	$V_{T(TO)}$	-	-	1.1	
On-state slope resistance, $T_j = 125\text{ }^\circ\text{C}$, $I_T = 1963\text{-}5890\text{ A}$	r_T	-	-	0.33	m Ω
Delay time, $T_j = 25\text{ }^\circ\text{C}$, $V_D = 0.67V_{DRM}$, $I_T = 1250\text{ A}$, $I_{FG} = 2\text{ A}$, $t_r = 0.5\text{ }\mu\text{s}$	t_d	-	-	3.5	μs
Turn off-time, $T_j = 125\text{ }^\circ\text{C}$, $I_T = 1250\text{ A}$, $di_T/dt = -5\text{ A}/\mu\text{s}$, $V_R \geq 100\text{ V}$, $V_D = 0.67V_{DRM}$, $dv_D/dt = 50\text{ V}/\mu\text{s}$	t_q	-	-	400	
Reverse recovery charge, $T_j = 125\text{ }^\circ\text{C}$, $I_T = 1250\text{ A}$, $di_T/dt = -5\text{ A}/\mu\text{s}$, $V_R \geq 100\text{ V}$	Q_{RR}	-	-	3000	μAs
Holding current, $T_j = 25\text{ }^\circ\text{C}$, $V_D = 12\text{ V}$	I_H	-	-	300	mA
Latching current, $T_j = 25\text{ }^\circ\text{C}$, $V_D = 12\text{ V}$, $I_{FG} = 2\text{ A}$, $t_r = 0.5\text{ }\mu\text{s}$	I_L	-	-	1500	
Gate trigger voltage, $V_D = 12\text{ V}$, $T_j = -60\text{ }^\circ\text{C}$ $T_j = 25\text{ }^\circ\text{C}$ $T_j = 125\text{ }^\circ\text{C}$	V_{GT}	-	-	3.5 2.5 2.0	V
Gate trigger current, $V_D = 12\text{ V}$, $T_j = -60\text{ }^\circ\text{C}$ $T_j = 25\text{ }^\circ\text{C}$ $T_j = 125\text{ }^\circ\text{C}$	I_{GT}	-	-	450 250 200	mA
Gate non-trigger direct voltage, $T_j = 125\text{ }^\circ\text{C}$, $V_D = 0.67V_{DRM}$	V_{GD}	0.25	-	-	V
Gate non-trigger direct current, $T_j = 125\text{ }^\circ\text{C}$, $V_D = 0.67V_{DRM}$	I_{GD}	15	-	-	mA
THERMAL PARAMETERS					
Thermal junction to case resistance, DC: double side cooled DC: anode side cooled DC: cathode side cooled	$R_{th(j-c)}$ $R_{th(j-cA)}$ $R_{th(j-cK)}$	-	-	0.015 0.030 0.030	$^\circ\text{C}/\text{W}$
Thermal case to heatsink resistance, double side cooled single side cooled	$R_{th(c-h)}$	-	-	0.004 0.008	
MECHANICAL PARAMETERS					
Weight	w	-	0.7		kg
Clamping force	F	30	-	36	kN
Maximum acceleration (at nominal mounting force)	a	-	-	100	m/s ²
Minimal gate-anode distance on insulator surface	D_s	-	24.7	-	mm



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Another length of outputs G and AC is permissible if required by clients

Fig. 1. Device Outline Drawing
(dimensions in mm)



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